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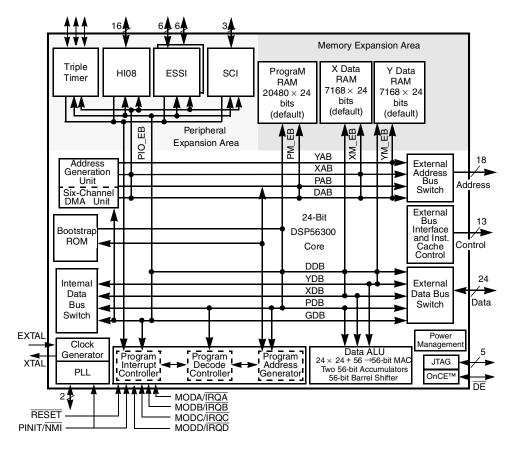
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## DSP56309

### 24-Bit Digital Signal Processor



The DSP56309 is intended for applications benefiting from a large amount of internal memory, such as wireless infrastructure applications.

Figure 1. DSP56309 Block Diagram

The DSP56309 is a member of the DSP56300 core family of programmable CMOS DSPs. The DSP56300 core includes a barrel shifter, 24-bit addressing, an instruction cache, and direct memory access (DMA). The DSP56309 offers 100 million multiply-accumulates per second (MMACS) at 3.0–3.6 V using an internal 100 MHz clock. The large internal memory is ideal for wireless infrastructure and wireless local-loop applications. The DSP56300 core family offers a new level of performance in speed and power provided by its rich instruction set and low-power dissipation, thus enabling a new generation of wireless, multimedia, and telecommunications products.

Note: This document contains information on a new product. Specifications and information herein are subject to change without notice.



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### Features

 Table 1 lists the features of the DSP56309 device.

Feature	Description					
High-Performance DSP56300 Core	<ul> <li>100 million multiply-accumulates per second (MMACS) with a 100 MHz clock at 3.3 V nominal</li> <li>Data arithmetic logic unit (Data ALU) with fully pipelined 24 × 24-bit parallel multiplier-accumulator (MAC), 56-bit parallel barrel shifter (fast shift and normalization; bit stream generation and parsing), conditional ALU instructions, and 24-bit or 16-bit arithmetic support under software control</li> <li>Program control unit (PCU) with position-independent code (PIC) support, addressing modes optimized for DSP applications (including immediate offsets), internal instruction cache controller, internal memory-expandable hardware stack, nested hardware DO loops, and fast auto-return interrupts</li> <li>Direct memory access (DMA) with six DMA channels supporting internal and external accesses; one-, two-and three-dimensional transfers (including circular buffering); end-of-block-transfer interrupts; and triggering from interrupt lines and all peripherals</li> <li>Phase-lock loop (PLL) allows change of low-power divide factor (DF) without loss of lock and output clock with skew elimination</li> <li>Hardware debugging support including on-chip emulation (OnCE) module, Joint Test Action Group (JTAG) test access port (TAP)</li> </ul>					
Internal Peripherals	<ul> <li>Enhanced 8-bit parallel host interface (HI08) supports a variety of buses (for example, ISA) and provides glueless connection to a number of industry-standard microcomputers, microprocessors, and DSPs</li> <li>Two enhanced synchronous serial interfaces (ESSI), each with one receiver and three transmitters (allows six-channel home theater)</li> <li>Serial communications interface (SCI) with baud rate generator</li> <li>Triple timer module</li> <li>Up to thirty-four programmable general-purpose input/output (GPIO) pins, depending on which peripherals are enabled</li> </ul>					
Internal Memories	<ul> <li>192 × 24-bit boo</li> <li>8 K × 24-bit RA</li> <li>Program RAM, i</li> <li>Program RAM</li> <li>20480 × 24 bits</li> <li>19456 × 24 bits</li> <li>24576 × 24 bits</li> <li>23552 × 24 bits</li> </ul>	M total	X data RAM, and X X Data RAM Size $7168 \times 24$ bits $7168 \times 24$ bits $5120 \times 24$ bits $5120 \times 24$ bits	Y data RAM sizes a <b>Y Data RAM</b> <b>Size</b> 7168 × 24 bits 7168 × 24 bits 5120 × 24 bits 5120 × 24 bits	are programmable Instruction Cache disabled enabled disabled enabled	e: Switch Mode disabled disabled enabled enabled
External Memory Expansion	<ul> <li>Data memory expansion to two 256 K × 24-bit word memory spaces using the standard external address lines</li> <li>Program memory expansion to one 256 K × 24-bit words memory space using the standard external address lines</li> <li>External memory expansion port</li> <li>Chip select logic for glueless interface to static random access memory (SRAMs)</li> <li>Internal DRAM Controller for glueless interface to dynamic random access memory (DRAMs)</li> </ul>					
Power Dissipation	<ul> <li>Very low-power CMOS design</li> <li>Wait and Stop low-power standby modes</li> <li>Fully static design specified to operate down to 0 Hz (dc)</li> <li>Optimized power management circuitry (instruction-dependent, peripheral-dependent, and mode-dependent)</li> </ul>					
Packaging	<ul> <li>144-pin TQFP package in lead-free or lead-bearing versions</li> <li>196-pin molded array plastic-ball grid array (MAP-BGA) package in lead-free or lead-bearing versions</li> </ul>					

#### Table 1. DSP56309 Features



### **Target Applications**

The DSP56309 is intended for applications benefiting from a large amount of internal memory, such as wireless infrastructure applications.

### **Product Documentation**

The documents listed in **Table 2** are required for a complete description of the DSP56309 device and are necessary to design properly with the part. Documentation is available from a local Freescale distributor, a Freescale semiconductor sales office, or a Freescale Semiconductor Literature Distribution Center. For documentation updates, visit the Freescale DSP website. See the contact information on the back cover of this document.

Name	Description	Order Number	
DSP56309 Technical Data	Description, features list, and specifications of the DSP56309	DSP56309	
DSP56309 User's Manual	Detailed functional description of the DSP56309 memory configuration, operation, and register programming	DSP56309UM	
DSP56300 Family Manual	Detailed description of the DSP56300 family processor core and instruction set	DSP56300FM	
Application Notes	Documents describing specific applications or optimized device operation including code examples	See the DSP56309 product website	

### Table 2. DSP56309 Documentation



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